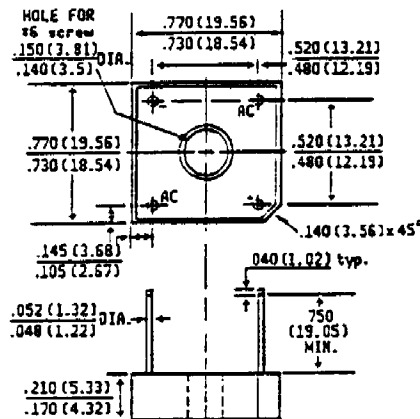
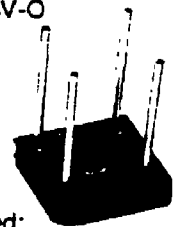


## GBPC8005 THRU GBPC810

GLASS PASSIVATED SINGLE - PHASE SILICON BRIDGE RECTIFIER  
VOLTAGE - 50 to 1000 Volts CURRENT - 8.0 Amperes

### FEATURES

- ◆ Glass passivated chip junctions
- ◆ Plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- ◆ High case dielectric strength
- ◆ Typical  $I_R$  less than  $0.5 \mu A$
- ◆ High surge current capability
- ◆ Ideal for printed circuit boards
- ◆ High temperature soldering guaranteed:  $265^\circ C / 10$  seconds at 5lbs., (2.3 kg) tension



Dimensions in inches  
and  
(millimeters)

### MECHANICAL DATA

**Case:** Reliable construction utilizing molded plastic technique

**Terminals:** Leads solderable per MIL-STD-202, Method 208

**Mounting Position:** Any

**Mounting:** Thru hole for #6 screw

**Weight:** 0.15 ounces, 4.4 grams

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at  $25^\circ C$  ambient temperature unless otherwise specified.  
60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

	SYMBOLS	GBPC 8005	GBPC 801	GBPC 802	GBPC 804	GBPC 806	GBPC 808	GBPC 810	UNITS
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Bridge Input Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Output Current at $T_C = 50^\circ C$ (Note 1) at $T_A = 40^\circ C$ (Note 2)	$I_{(AV)}$				8.0				Amps
Peak Forward Surge Current Single sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$				200				Amps
Rating for fusing ( $t < 8.3ms$ )	$I^2 t$				160				$A^2s$
Maximum Instantaneous Forward Voltage Drop per element at 4.0 Amperes	$V_F$				1.0				Volts
Maximum DC Reverse Current at Rated DC Blocking Voltage per Bridge Element	$I_R$				10.0				$\mu A$
Typical Junction Capacitance per element (Note 3)	$C_J$				500				pf
Typical Thermal Resistance (Note 1)	$R_{\theta JC}$				100				$^\circ C/W$
Operating Temperature Range	$T_J$				-55 to +150				$^\circ C$
Storage Temperature Range	$T_{STG}$				-55 to +150				$^\circ C$

NOTES: 1. Unit mounted on 8.6" sq. x .24" thick (22 x 22 x 0.6 cm) Al. plate.  
2. Unit mounted on P.C. board at .375" .9.5mm lead lengths.  
3. Measured at 1 MHz and applied reverse voltage of 4.0 volts.

